

SID

Factory: Rot am See

Article:

708

ML12

Provided:

Stockburger, Olesja

Customer:

Date:

03.02.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	 B00
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	204		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		35	L2	
A-RS-FR4-ML-0.30mm-035+035-TG150-HF	50200655	300		
		35	L3	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	204		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		35	L4	
A-RS-FR4-ML-0.30mm-035+035-TG150-HF	50200655	300		
		35	L5	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	204		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		35	L6	
A-RS-FR4-ML-0.30mm-035+035-TG150-HF	50200655	300		
		35	L7	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	204		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		35	L8	
A-RS-FR4-ML-0.30mm-035+035-TG150-HF	50200655	300		
		35	L9	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	204		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		35	L10	
A-RS-FR4-ML-0.30mm-035+035-TG150-HF	50200655	300		
		35	L11	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	204		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

3144 µm

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